

2SK1521-F 供应商 2SK1521, 2SK1522

Silicon N Channel MOS FET

REJ03G0949-0200

(Previous: ADE-208-1289)

Rev.2.00 Sep 07, 2005

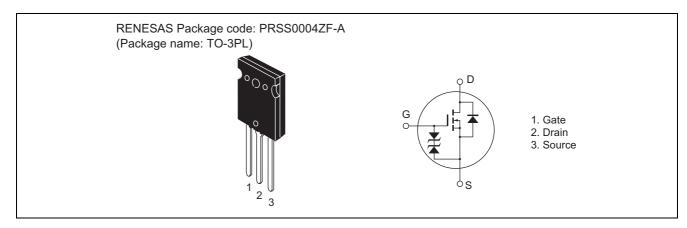
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 120 \text{ ns}$)
- Suitable for motor control, switching regulator, DC-DC converter

Outline



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 $(Ta = 25^{\circ}C)$

| Item | | Symbol | Ratings | Unit | |
|---|---------|--------------------------|-------------|------|--|
| Drain to source voltage 2SK1521 | | V _{DSS} | 450 | V | |
| | 2SK1522 | | 500 | | |
| Gate to source voltage | | V_{GSS} | ±30 | V | |
| Drain current | | I _D | 50 | А | |
| Drain peak current | | I _{D(pulse)} *1 | 200 | А | |
| Body to drain diode reverse drain current | | I _{DR} | 50 | А | |
| Channel dissipation | | Pch*2 | 250 | W | |
| Channel temperature | | Tch | 150 | °C | |
| Storage temperature | | Tstg | −55 to +150 | °C | |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25$ °C

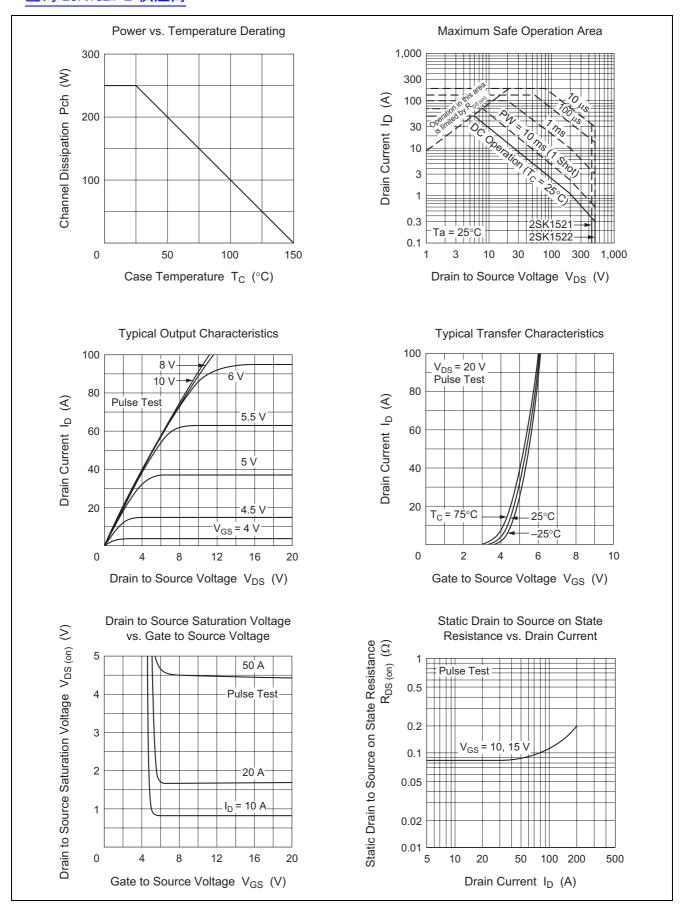
Electrical Characteristics

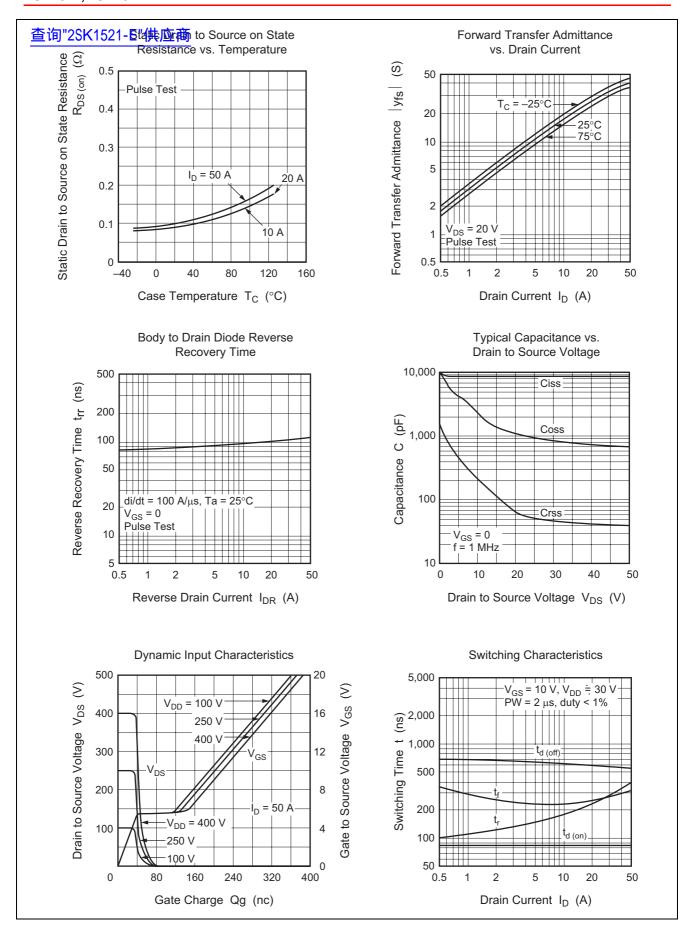
 $(Ta = 25^{\circ}C)$

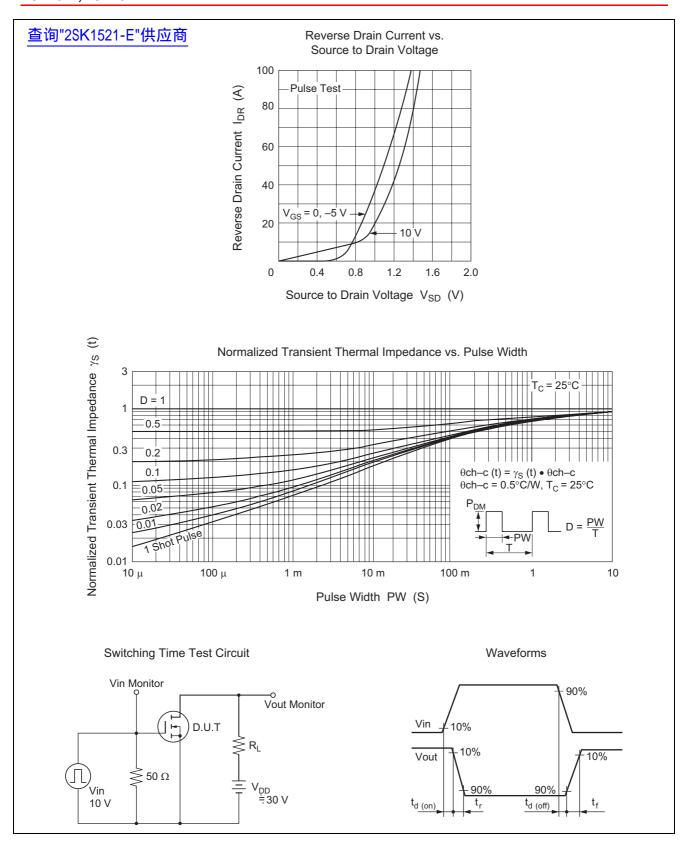
| Item | | Symbol | Min | Тур | Max | Unit | Test conditions |
|--------------------------------------|-----------|----------------------|-----|-------|------|------|--|
| Drain to source | 2SK1521 | $V_{(BR)DSS}$ | 450 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| breakdown voltage | 2SK1522 | | 500 | | | | |
| Gate to source breakdow | n voltage | $V_{(BR)GSS}$ | ±30 | | 1 | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | | I_{GSS} | _ | | ±10 | μΑ | $V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain | 2SK1521 | I _{DSS} | _ | _ | 250 | μΑ | V _{DS} = 360 V, V _{GS} = 0 |
| current | 2SK1522 | | | | | | $V_{DS} = 400 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | | V _{GS(off)} | 2.0 | | 3.0 | V | I _D = 1 mA, V _{DS} = 10 V |
| Static drain to source on | 2SK1521 | R _{DS(on)} | _ | 0.08 | 0.10 | Ω | $I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$ |
| state resistance | 2SK1522 | | _ | 0.085 | 0.11 | | |
| Forward transfer admittance | | y _{fs} | 22 | 35 | _ | S | $I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$ |
| Input capacitance | | Ciss | _ | 8700 | _ | pF | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$ |
| Output capacitance | | Coss | _ | 2400 | _ | pF | f = 1 MHz |
| Reverse transfer capacitance | | Crss | _ | 235 | _ | pF | |
| Turn-on delay time | | t _{d(on)} | _ | 85 | _ | ns | $I_D = 25 \text{ A}, V_{GS} = 10 \text{ V},$ |
| Rise time | | t _r | _ | 250 | _ | ns | $R_L = 1.2 \Omega$ |
| Turn-off delay time | | $t_{d(off)}$ | _ | 600 | _ | ns | |
| Fall time | | t _f | _ | 250 | - | ns | |
| Body to drain diode forward voltage | | V_{DF} | _ | 1.1 | _ | V | $I_F = 50 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse recovery | | t _{rr} | _ | 120 | _ | ns | $I_F = 50 \text{ A}, V_{GS} = 0,$ |
| time | | | | | | | $di_F/dt = 100 A/\mu s$ |

Note: 3. Pulse test

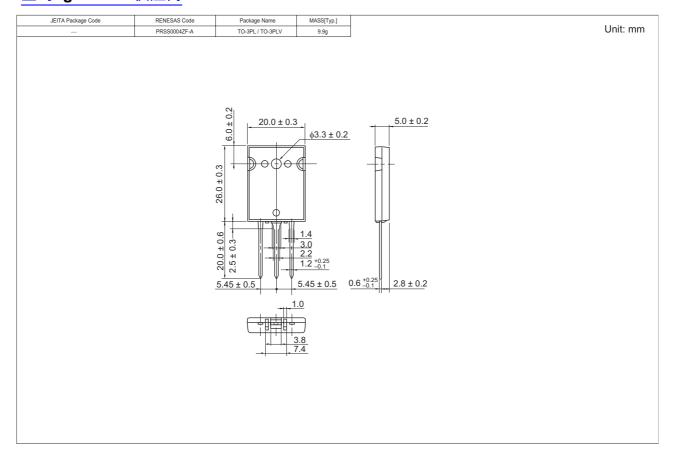
Main "Characteristics药







Package Dimenstons



Ordering Information

| Part Name | Quantity | Shipping Container | | |
|-----------|----------|--------------------|--|--|
| 2SK1521-E | 500 pcs | Box (Case) | | |
| 2SK1522-E | 500 pcs | Box (Case) | | |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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